

Materials Declaration Form

IPC Form Type *	1752 Distribute	Version	2
Sectionals *	Material Info	Subsectionals *	A-D
	Manufacturing Info		* : Required Field

Supplier Information							
Company Name *	STMicroelectronics Response Date *		2018-08-09				
Contact Name *	Refer to Supplier Comment section		Refer to Supplier Comment section				
Contact Phone *	Refer to Supplier Comment section Contact Email *		Refer to Supplier Comment section				
Authorized Representative *	Rossana Bonaccorso Representative Title		ADG MD CHAMPION				
Representative Phone *	Refer to Supplier Comment section	ent section Representative Email * Refer to Supplier Comment section					
Supplier Comment	Online Technical Support - STMicroele http://www.st.com/web/en/support/s						

Uncertainty Statement

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Legal Statement

Supplier Acceptance * true Legal Declaration * Standard

Legal Statement

Supplier certifies that it gathered the provided information and such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as omprehensive as the certification in this paragraph. If the Company and the Supplier enter into a writter agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.

Product								
Mfr Item Number	Mfr Item Name	Version Mfr Site		Date				
STGWA40HP65FB2	TDWT*JWFEP5F	А	Z8GA	2018-08-09				
	Amount	UoM	Unit type	ST ECOPACK Grade				
	6100.00	mg	Each	ECOPACK® 2				
Comment	ECOPACK® 2 is STMicroelectronics trade name for ROHS compliant device without Brominated and Chlorinated compound (900ppm) and without Antimony oxide flame retardant (in each organic material)							

Manufacturing information							
J-STD-020 MSL Rating	Classification Temp	Nbr of Reflow Cycles					
Not Applicable	Not Applicable	Not Applicable					
Bulk Solder Termination	Terminal Plating	Terminal Base Alloy	Comment	life.augmented			
Not Applicable	Tin (Sn), matte	Copper Alloy		111010			

Package Designator	Size	Nbr of instances	Shape	
SIP	15.75X20.15X5.15	3	Through-hole	
Comment	Package: TO-247 LONG LEADS			

QueryList: RoHS Directive 2011/65/EU-July 2011 – Annex II amended by Directive 2015/863-March 2015								
	Query Response							
1 - Product(s) meets EU RoHS requiremen	- Product(s) meets EU RoHS requirement without any exemptions							
2 - Product(s) meets EU RoHS requiremen apply)	2 - Product(s) meets EU RoHS requirements except lead in solder and this usage may qualify under the lead in solder '7b' exemption (other selected exemptions may papely) FALSE							
3 - Product(s) meets EU RoHS requiremen	3 - Product(s) meets EU RoHS requirements by application of the selected exemption(s) FALSE							
4 - Product(s) does not meet EU RoHS req	4 - Product(s) does not meet EU RoHS requirements and is not under exemptions FALSE							
Exemption Id. Description								

QueryList: ELV directive: 2000/53/EC amended 2017/2096 _November 2017							
Query Response							
1 - Product(s) meets EU ELV requirements without any exemptions							
2 - Product(s) meets EU RoHS requiremen	FALSE						
Exemption Id. Description							

QueryList: California Prop65 list, dated 25th May 2018							
Qu	Response						
1 - The product does not contain identified substance from California Prop 65 List, no exposure to consumers is foreseen							
2 - The product is containing below substance(s) from California Prop 65 List, no expo	TRUE						
Substance	ppm in product						
Nickel	191						

QueryList: REACH-27th June 2018							
	Response						
1 - Product(s) does not contain REACH Sub	ostances Of Very High Concern above the lin	mits per the definition within REACH		TRUE			
CategoryLevel_Name	ppm in product						
2 - Product(s) does not contain REACH definition within REACH	2 - Product(s) does not contain REACH Substances Of Very High Concern in any Embedded article nor Homogeneous Material above the limits per the definition within REACH						
CategoryLevel_Name	ppm in Article /Homogeneous Material						

Material Composition Decla note : Substance present wit	nration: th less 0.001mg will not be declared in this	is document				Mfr Item Name	TDWT	JWFEP5F				
Homogeneous Material	Material Group	Mass	UoM	Level	Substance Category	Substance	CAS	Exempt	Mass	UoM	Concentration in homogeneous material (ppm)	Concentration in product (ppm)
Die	M-011 Other inorganic materials	3.257	mg	supplier	die	Silicon (Si)	7440-21-3		2.778	mg	852985	455
				supplier	metallization	Aluminium (Al)	7429-90-5		0.180	mg	55269	30
				supplier	Passivation	Silicon Nitride	12033-89-5		0.039	mg	11975	6
				supplier	Passivation	Silicon Oxide	7631-86-9		0.074	mg	22722	12
				supplier	back side metallization	Titanium (Ti)	7440-32-6		0.004	mg	1228	1
				supplier	back side metallization	Gold (Au)	7440-57-5		0.001	mg	306	0
				supplier	back side metallization	Nickel (Ni)	7440-02-0		0.054	mg	16581	9
				supplier	back side metallization	Vanadium (V)	7440-62-2		0.004	mg	1228	1
				supplier	back side metallization	Silver (Ag)	7440-22-4		0.020	mg	6141	3
				supplier	polymer die coating	Probimide	Proprietary		0.103	mg	31565	16
Leadframe	Copper & its alloys	3999.108	mg	supplier	alloy	Copper(CU)	7440-50-8		3993.909	mg	998700	654739
				supplier	alloy	Iron (Fe)	7439-89-6		3.999	mg	1000	656
				supplier	alloy	Phosphorus(P)	12185-10-3		0.089	mg	22	15
				supplier	metallization	Nickel (Ni)	7440-02-0		1.111	mg	278	182
Solder paste	Solder	3.754	mg	supplier	solder	Tin(Sn)	7440-31-5		2.439	mg	649707	400
				supplier	solder	Silver(Ag)	7440-22-4		0.938	mg	249867	154
				supplier	solder	Antimony	7440-36-0		0.377	mg	100426	62
Bonding wires	Other organic materials	4.894	mg	supplier	wire	Aluminium (Al)	7429-90-5		4.894	mg	1000000	802
Encapsulation	Other organic materials	2050.719	mg	supplier	mold compound	Epoxy resin	29690-82-2		143.550	mg	70000	23533
				supplier	mold compound	Phenol resin	9003-35-4		51.268	mg	25000	8405
				supplier	mold compound	Silica	60676-86-0		1538.042	mg	750001	252138
				supplier	mold compound	Metal hydroxide	21645-51-2		307.606	mg	149999	50427
				supplier	mold compound	Carbon black	1333-86-4		10.253	mg	5000	1681
Finishing	Solder	38.268	mg	supplier	solder alloy	Tin(Sn)	7440-31-5		38.268	mg	1000000	6273